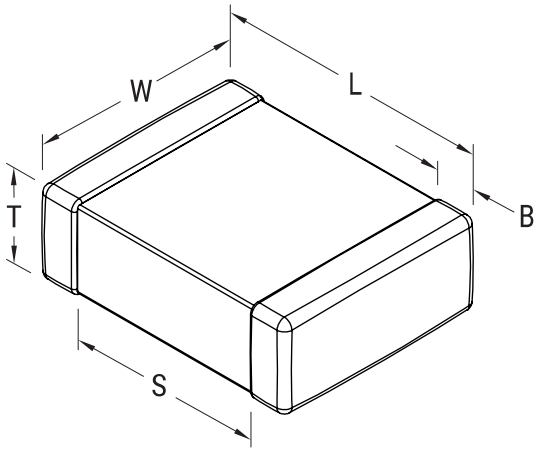
C0402C331GATAC7411

SMD Comm X8G HT150C, Ceramic, 330 pF, 2%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0402 / 1005



Click here for the 3D model.

General Information	
Series	SMD Comm X8G HT150C
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable
Features	High Temperature, Ultra-Stable
RoHS	Yes
Termination	Tin
Marking	No
Typical Component Weight	1.16 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
L	1mm +/-0.05mm
W	0.5mm +/-0.05mm
T	0.55mm +/-0.05mm
S	0.3mm MIN
B	0.3mm +/-0.1mm
Case Code (EIA / mm)	0402 / 1005

Packaging Specifications	
Packaging	T&R, 330mm, Paper Tape
Packaging Quantity	50000

Specifications	
Capacitance	330 pF
Measurement Condition	1 MHz 1.0Vrms
Tolerance	2%
Voltage DC	250 VDC
Dielectric Withstanding Voltage	625 VDC
Temperature Range	-55/+150°C
Temp. Coefficient	X8G
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	100 GOhms

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